

# PTGH6065BY

## Features

### IGBT Discrete

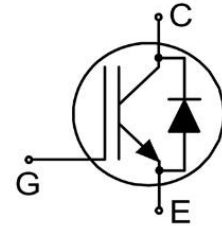
- Rated to 650V at 60Amps @ $T_j = 25^{\circ}\text{C}$
- $V_{CE(sat)}=2.10\text{V}$  @  $I_C=60\text{A}$
- Low switching losses
- Positive Temperature Coefficient
- High Ruggedness, Temperature Stable
- Maximum Junction Temperature  $175^{\circ}\text{C}$
- High short circuit capability (5us)

## Application

- High frequency switching application
- Medical applications
- Uninterruptible power supply, UPS
- Motion/Servo control



PKG type : TO-247



## Absolute Maximum Ratings

Symbol	Parameter	Value	Unit	
$BV_{CES}$	Collector-Emitter Breakdown Voltage	650	V	
$I_C$	DC Collector Current	$T_C=25^{\circ}\text{C}$	120	A
		$T_C=100^{\circ}\text{C}$	60	
$I_{CM}$	Pulsed Collector Current	240	A	
$I_F$	Diode Forward Current	$T_C=25^{\circ}\text{C}$	60	A
		$T_C=100^{\circ}\text{C}$	30	
$I_{F, Pulse}$	Diode Pulsed Current	120	A	
$V_{GE}$	Continuous Gate-Emitter Voltage	$\pm 20$	V	
$V_{GE}$	Transient Gate-Emitter Voltage	$\pm 30$		
$P_D$	Power Dissipation	$T_C=25^{\circ}\text{C}$	333	W
$t_{SC}$	Short circuit withstand time	5	$\mu\text{s}$	
$T_{vj}$	Operating Junction Temperature Range	-40 to 175	$^{\circ}\text{C}$	
$T_{stg}$	Storage Temperature Range	-55 to 150		



## Package Marking and Ordering Information

Device Marking	Device	Package	Packing Method	Tape width	Quantity
PTGH6065BY	PTGH6065	TO-247	TUBE	-	30

## Electrical Characteristics

 $T_J=25^{\circ}\text{C}$  Unless Otherwise Specified

### Static Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit	
			Min	Typ	Max		
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$I_C=250\mu\text{A}$ , $V_{GE}=0\text{V}$	650	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=60\text{A}$ , $V_{GE}=15\text{V}$	$T_J=25^{\circ}\text{C}$	-	2.10	2.40	V
			$T_J=125^{\circ}\text{C}$	-	2.40	-	
			$T_J=150^{\circ}\text{C}$	-	2.50	-	
$V_{GE(TH)}$	Gate-Emitter Threshold Voltage	$V_{CE}=V_{GE}$ , $I_C=0.8\text{mA}$	4.1	5.1	6.1	V	
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{CE}=650\text{V}$ , $V_{GE}=0\text{V}$	$T_J=25^{\circ}\text{C}$	-	-	0.25	mA
			$T_J=150^{\circ}\text{C}$	-	-	4.00	
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=\pm 20\text{V}$ , $V_{CE}=0\text{V}$	-	-	100	nA	

### Dynamic Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit	
			Min	Typ	Max		
$Q_G$	Total Gate Charge	$V_{CC}=300\text{V}$ , $I_C=60\text{A}$ , $V_{GE}=15\text{V}$	-	0.24	-	$\mu\text{C}$	
$V_F$	Diode Forward Voltage	$I_F=30\text{A}$	$T_J=25^{\circ}\text{C}$	-	1.90	2.60	V
			$T_J=125^{\circ}\text{C}$	-	1.85	-	
			$T_J=150^{\circ}\text{C}$	-	1.75	-	
$C_{IES}$	Input Capacitance	$V_{CE}=25\text{V}$ , $V_{GE}=0\text{V}$ , $f=1\text{MHz}$	-	2.04	-	nF	
$C_{RES}$	Reverse Transfer Capacitance		-	0.84	-		
$I_{C(SC)}$	Short circuit collector current	$V_{GE}=15\text{V}$ , $t_{SC}\leq 5\mu\text{s}$ , $V_{CC}=400\text{V}$ , $T_J\leq 150^{\circ}\text{C}$	-	280	-	A	



## Electrical Characteristics

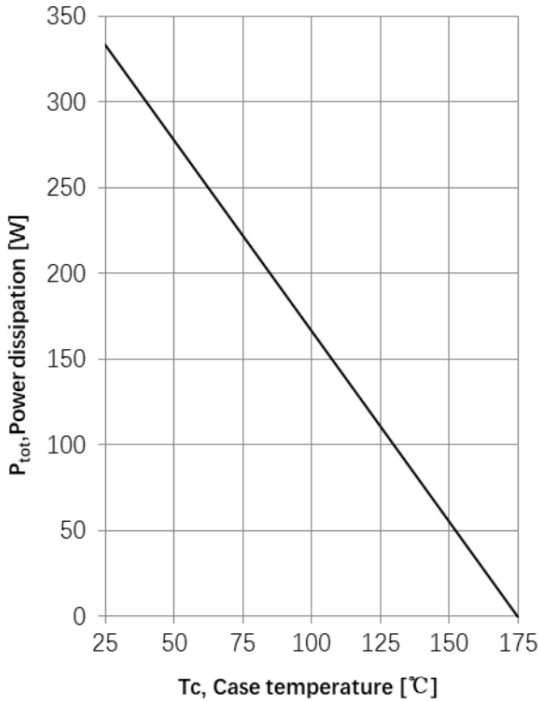
### Switching Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ	Max	
$t_{d(on)}$	Turn-On Delay Time	$V_{GE}=0\sim 15V,$ $V_{CC}=400V,$ $L_S=60nH, I_C=60A,$ $R_G=10\Omega$	-	18	-	ns
$t_r$	Turn-On Rise Time		-	17	-	
$t_{d(off)}$	Turn-Off Delay Time		-	16	-	
$t_f$	Turn-Off Fall Time		-	75	-	
$E_{on}$	Turn-On Switching Energy	$T_J=25^\circ C$ $T_J=125^\circ C$ $T_J=150^\circ C$	-	65	-	mJ
$E_{off}$	Turn-Off Switching Energy		-	59	-	
$E_{rec}$	Reverse Recovery Energy		-	163	-	
$I_{rr}$	Reverse Recovery Current		-	176	-	
$Q_{rr}$	Reverse Recovery Charge	$I_F=30A, V_R=400V,$ $di/dt=-350A/\mu s$	-	182	-	uC
$T_{rr}$	Reverse Recovery Time		-	62	-	
			-	70	-	
			-	82	-	

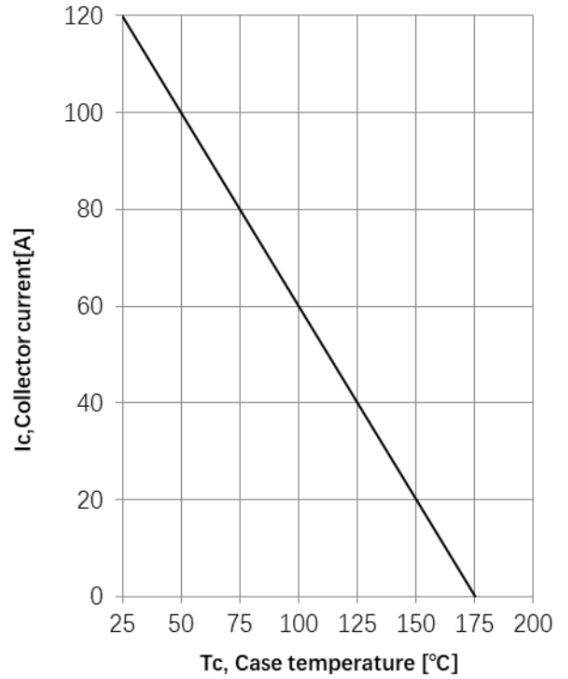
### Thermal Characteristics

Symbol	Parameter	Numerical	Unit
$R_{\theta(J-A)}$	Thermal Resistance Junction-to-Ambient	40	K/W
$R_{\theta(J-C)}$	Thermal Resistance Junction-to-Case for IGBT	0.45	
$R_{\theta(J-C)}$	Thermal Resistance Junction-to-Case for Diode	1.05	

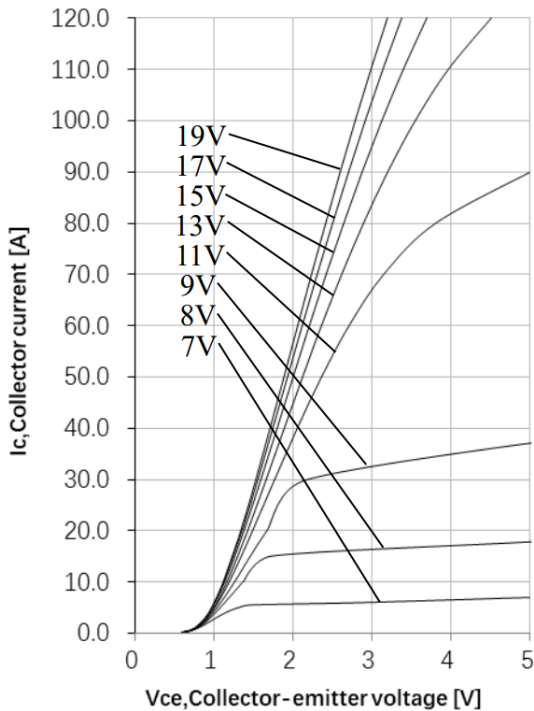
# Typical Characteristics



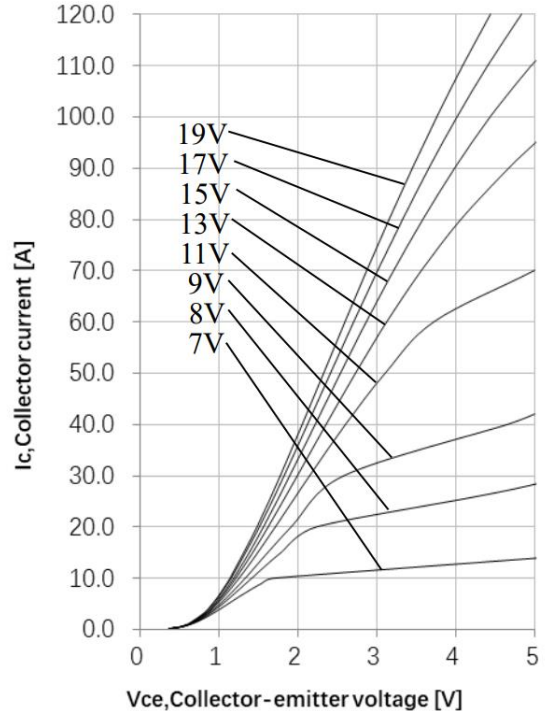
**Figure 1. Power dissipation as a function of case temperature ( $T_J \leq 175^\circ\text{C}$ )**



**Figure 2. Collector current as a function of case temperature ( $V_{GE} \geq 15\text{V}$ ,  $T_J \leq 175^\circ\text{C}$ )**

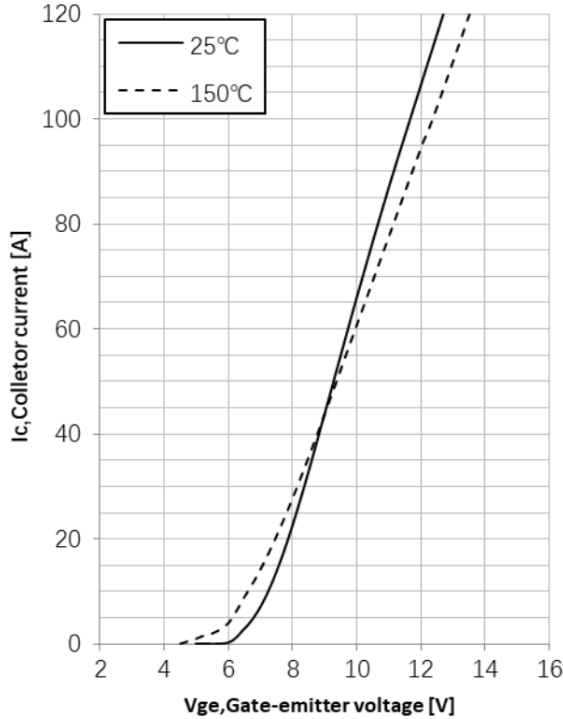


**Figure 3. Typical output Characteristics ( $T_J = 25^\circ\text{C}$ )**

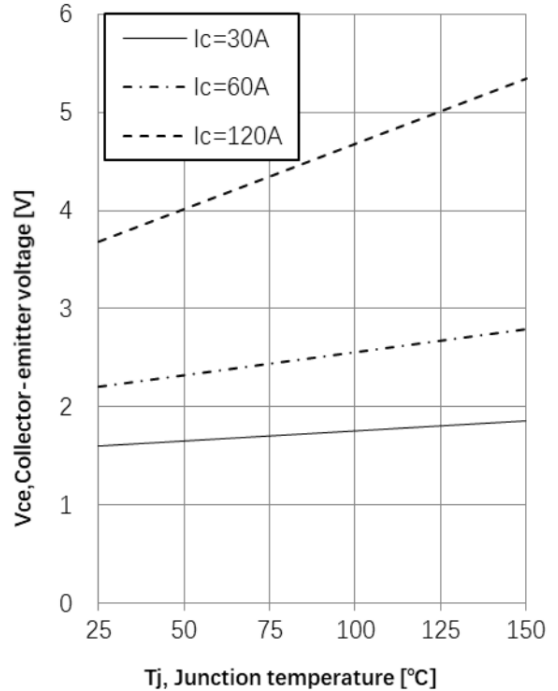


**Figure 4. Typical output Characteristics ( $T_J = 150^\circ\text{C}$ )**

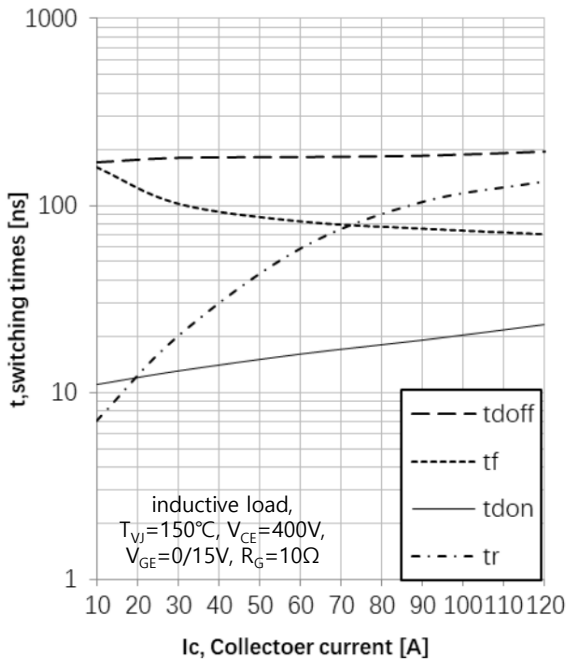
# Typical Characteristics



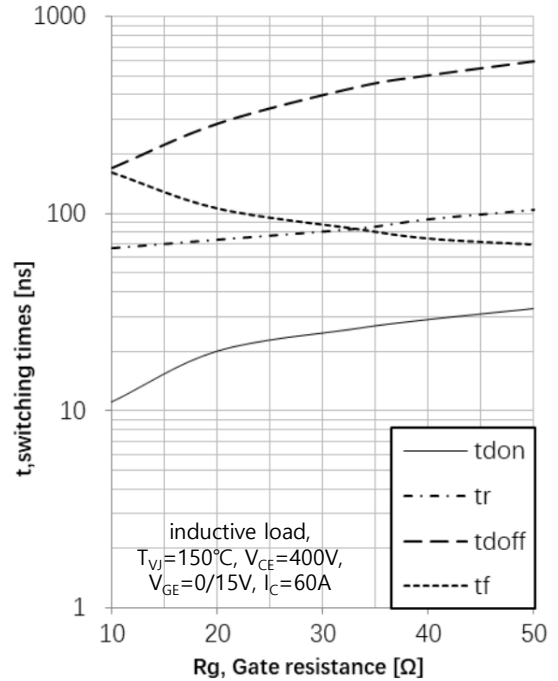
**Figure 5. Typical transfer characteristic ( $V_{GE}=20V$ )**



**Figure 6. Typical collector-emitter saturation voltage as a function of  $T_J$  ( $V_{GE}=15V$ )**



**Figure 7. Typical switching time as a function of collector current**



**Figure 8. Typical switching times as a function of gate resistance**

# Typical Characteristics

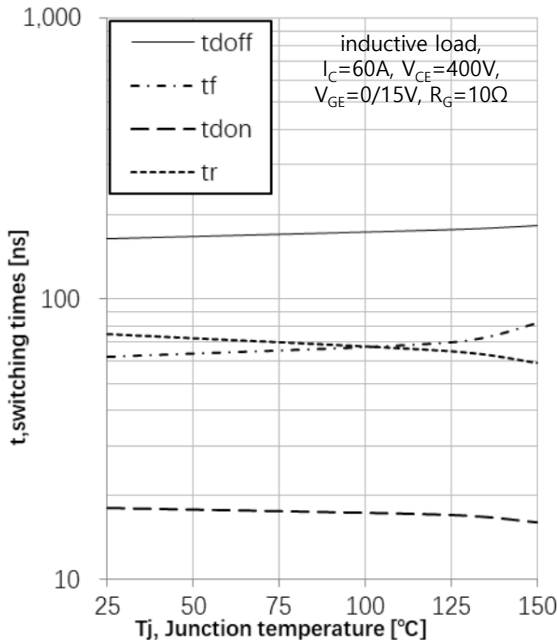


Figure 9. Typical switching times as a function of junction temperature

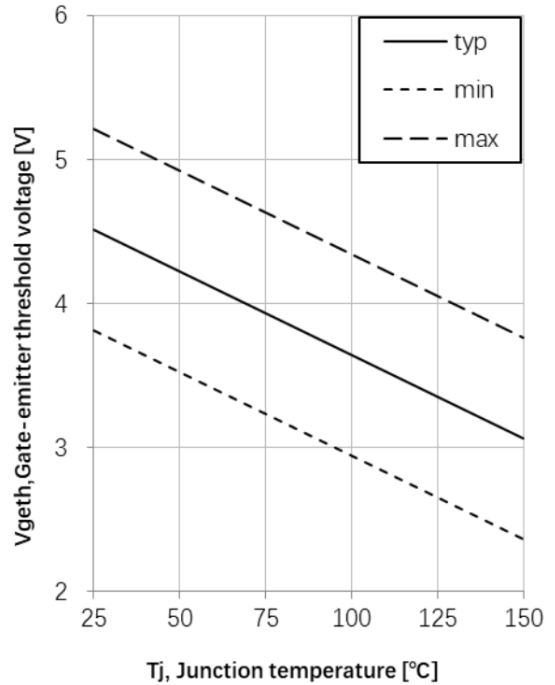


Figure 10. Gate to emitter threshold voltage as a function of junction temperature (I<sub>C</sub>=0.75mA)

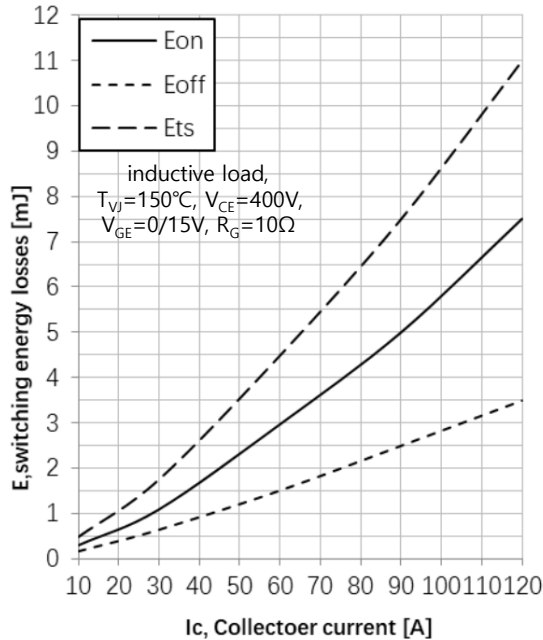


Figure 11. Typical switching energy losses as a function of collect current

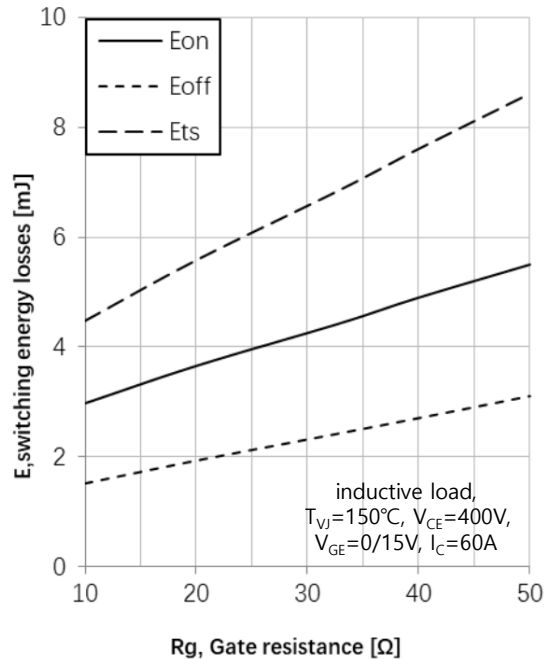


Figure 12. Typical switching energy losses as a function of gate resistance

# Typical Characteristics

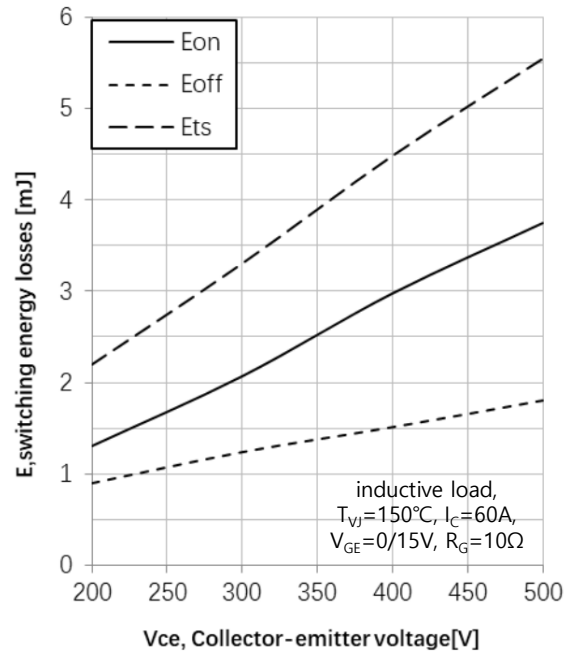
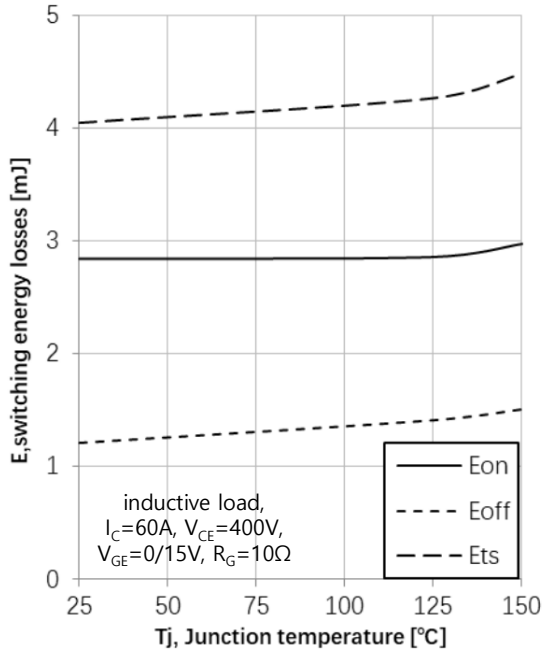


Figure 13. Typical switching energy losses as a function of junction temperature

Figure 14. Typical switching energy losses as a function of collector to emitter voltage

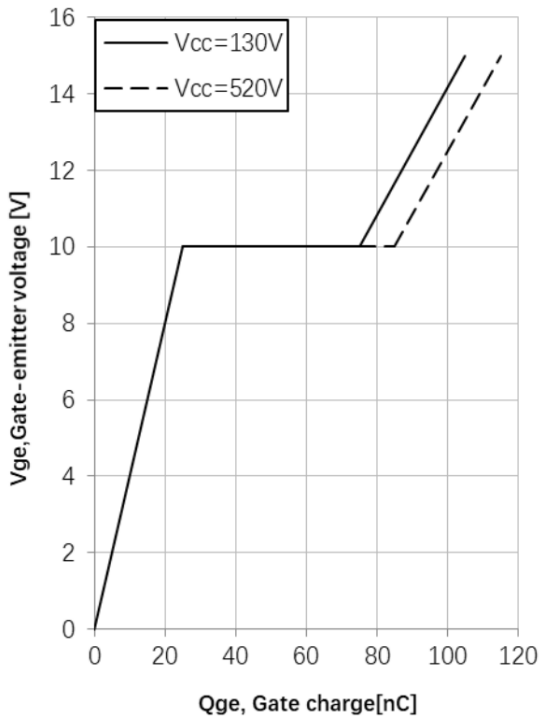


Figure 15. Typical gate charge ( $I_C=60A$ )

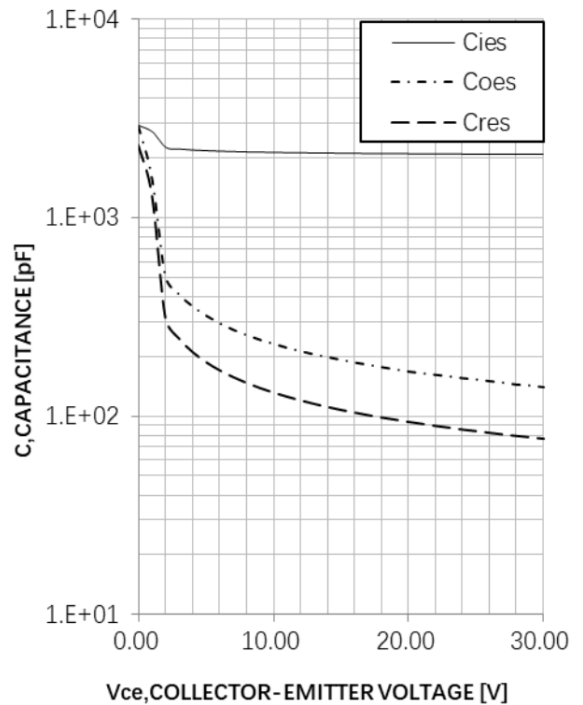


Figure 16. Typical capacitance as a function of collector to emitter voltage

# Typical Characteristics

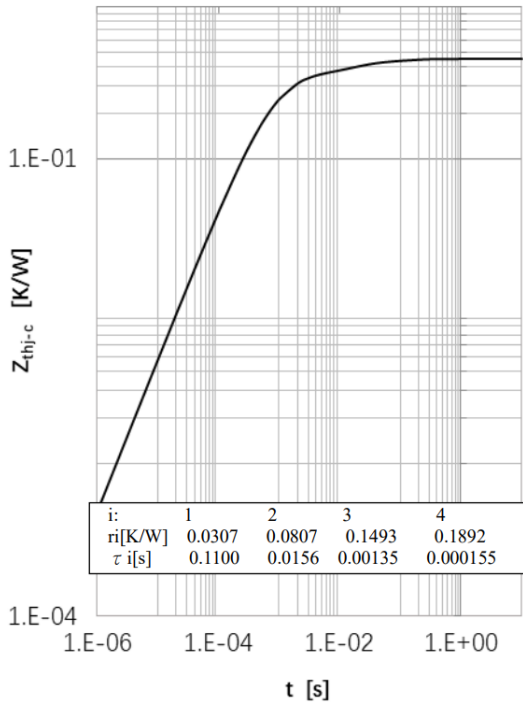


Figure 17. IGBT Transient Thermal Impedance

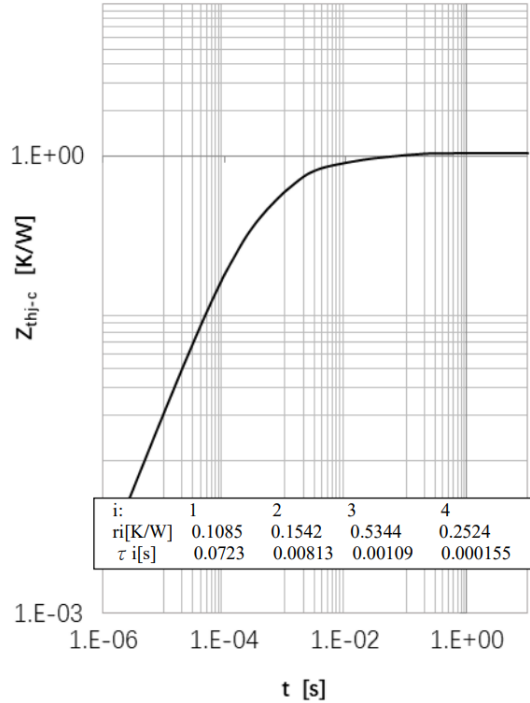


Figure 18. Diode Transient Thermal Impedance

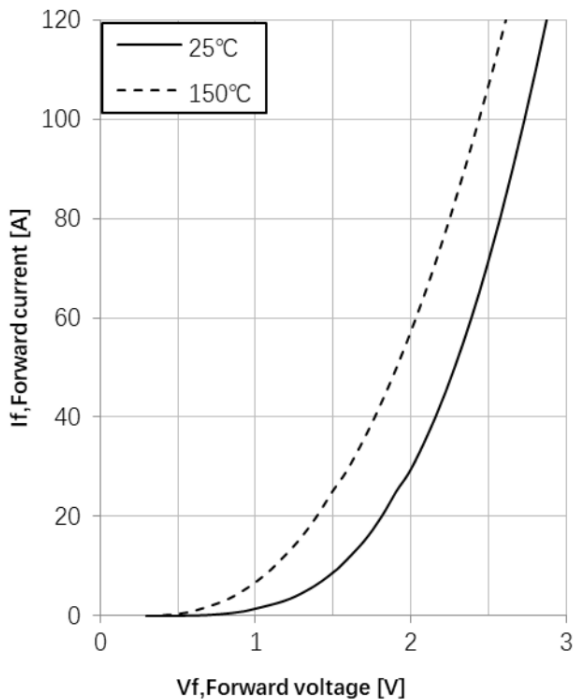


Figure 19. Diode forward current as a function of forward voltage

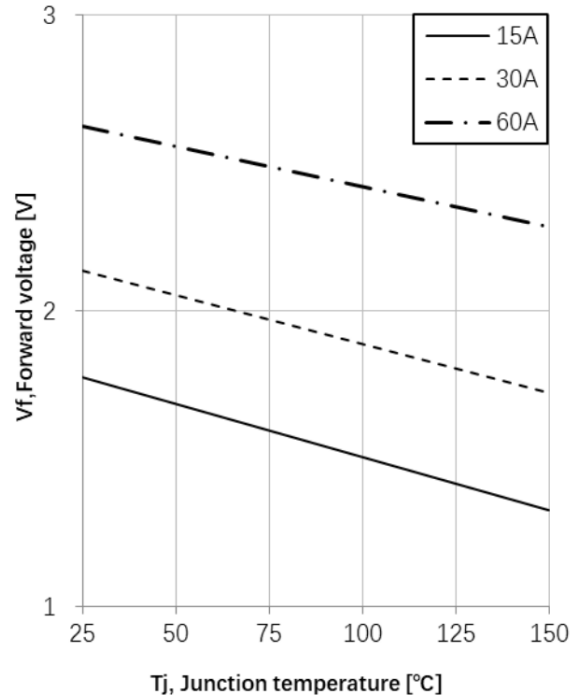
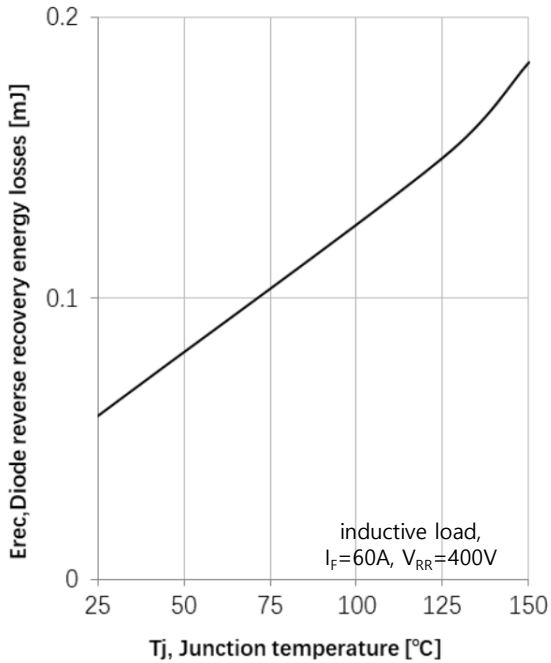


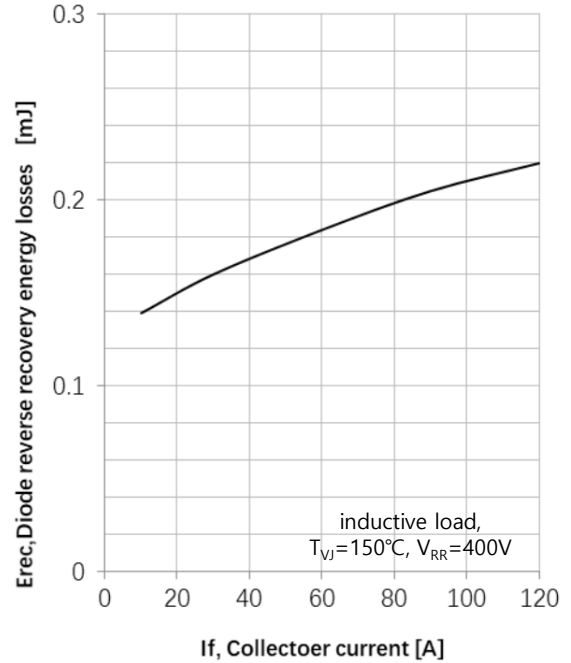
Figure 20. Typical diode forward voltage as a function of junction temperature



## Typical Characteristics



**Figure 21. Typical diode reverse recovery energy losses as a function of junction temperature**

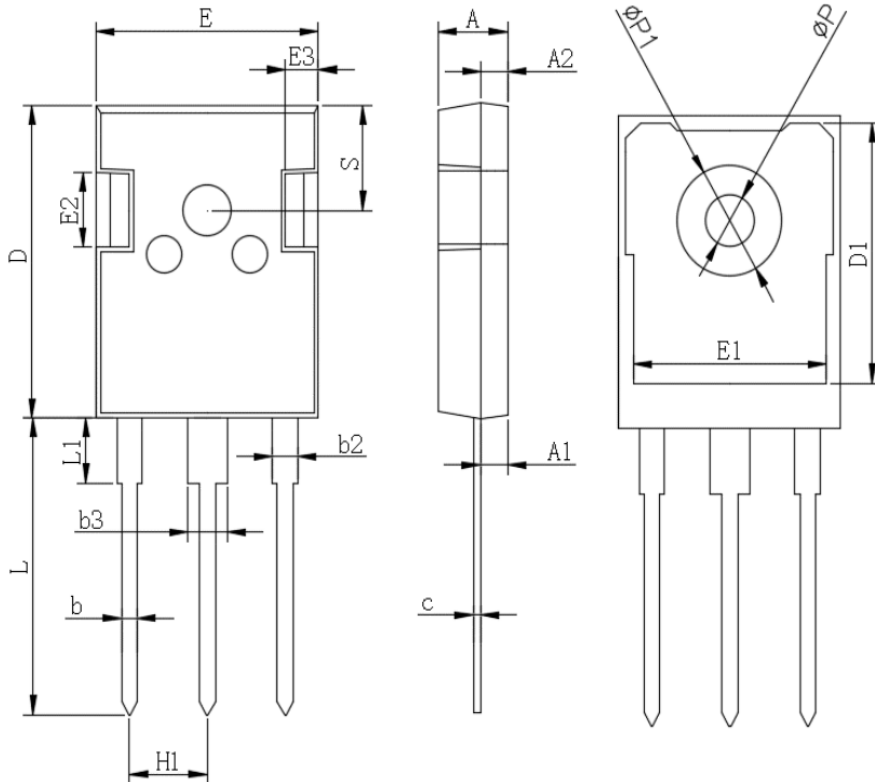


**Figure 22. Typical diode reverse recovery energy losses as a function of collect current**



## Package Outline

Unit : mm



SYMBOL	DIMENSIONS	
	MIN	MAX
<b>A</b>	4.80	5.20
<b>A1</b>	2.21	2.61
<b>A2</b>	1.85	2.15
<b>b</b>	1.0	1.4
<b>b2</b>	1.91	2.21
<b>C</b>	0.5	0.7
<b>D</b>	20.70	21.30
<b>D1</b>	16.25	16.85
<b>E</b>	15.50	16.10
<b>E1</b>	13.0	13.6
<b>E2</b>	4.80	5.20
<b>E3</b>	2.30	2.70
<b>L</b>	19.62	20.22
<b>L1</b>	-	4.30
<b>ΦP</b>	3.40	3.80
<b>ΦP1</b>	-	7.30
<b>S</b>	6.15 Typ	
<b>H1</b>	5.44 Typ	
<b>b3</b>	2.80	3.20